

40V, 600 mA, PNP switching transistor 6 March 2015

Product data sheet

1. General description

PNP switching transistor in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

NPN complement: PMBT2222

60V variant: PMBT2907A

2. Features and benefits

- Single general-purpose switching transistor
- AEC-Q101 qualified

3. Applications

• Switching and linear amplification

4. Quick reference data

| Table 1. C | Quick reference data | | | | | |
|------------------|---------------------------|---|-----|-----|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{CEO} | collector-emitter voltage | open base | - | - | -40 | V |
| I _C | collector current | | - | - | -600 | mA |
| h _{FE} | DC current gain | V_{CE} = -10 V; I _C = -150 mA; T _{amb} = 25 °C | 100 | - | 300 | |

5. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|-------------|-------------------------|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | В | base | 3 | С |
| 2 | Е | emitter | | в |
| 3 | С | collector | 1 2 TO-236AB (SOT23) | E sym132 |





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6. Ordering information

| Table 3. Ordering information | | | | | | | |
|-------------------------------|----------|--|---------|--|--|--|--|
| Type number | Package | | | | | | |
| | Name | Description | Version | | | | |
| PMBT2907 | TO-236AB | plastic surface-mounted package; 3 leads | SOT23 | | | | |

7. Marking

| Table 4. Marking codes | |
|------------------------|--------------|
| Type number | Marking code |
| | [1] |
| PMBT2907 | %2B |

[1] % = placeholder for manufacturing site code

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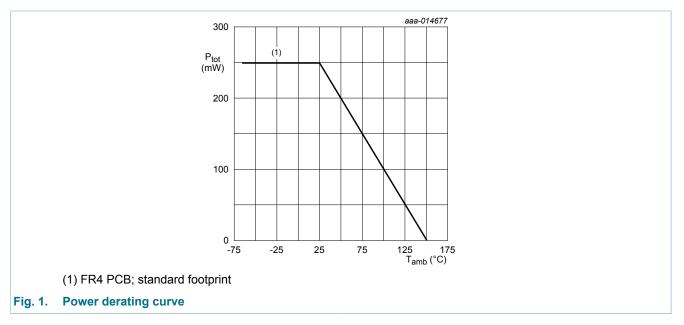
8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|------------------|---------------------------|-------------------------------------|-----|-----|------|------|
| V _{CBO} | collector-base voltage | open emitter | | - | -60 | V |
| V _{CEO} | collector-emitter voltage | open base | | - | -40 | V |
| V _{EBO} | emitter-base voltage | open collector | | - | -5 | V |
| I _C | collector current | | | - | -600 | mA |
| I _{CM} | peak collector current | single pulse; t _p ≤ 1 ms | | - | -800 | mA |
| I _{BM} | peak base current | | | - | -200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [1] | - | 250 | mW |
| Tj | junction temperature | | | - | 150 | °C |
| T _{amb} | ambient temperature | | | -65 | 150 | °C |
| T _{stg} | storage temperature | | | -65 | 150 | °C |

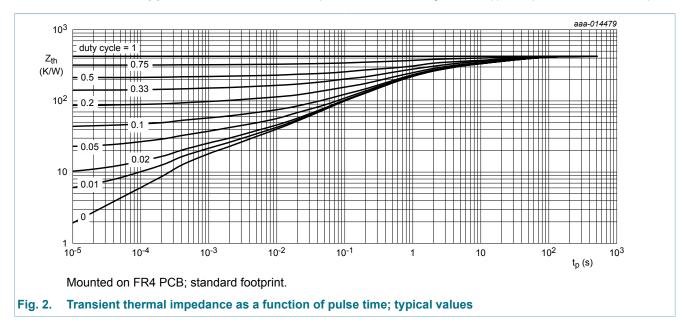
[1] Transistor mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



9. Thermal characteristics

| Table 6. | Thermal characteristics | | | | | | |
|----------------------|---|--|-----|---------|----------------|---------------|-----------------|
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | [1] | - | - | 500 | K/W |
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[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

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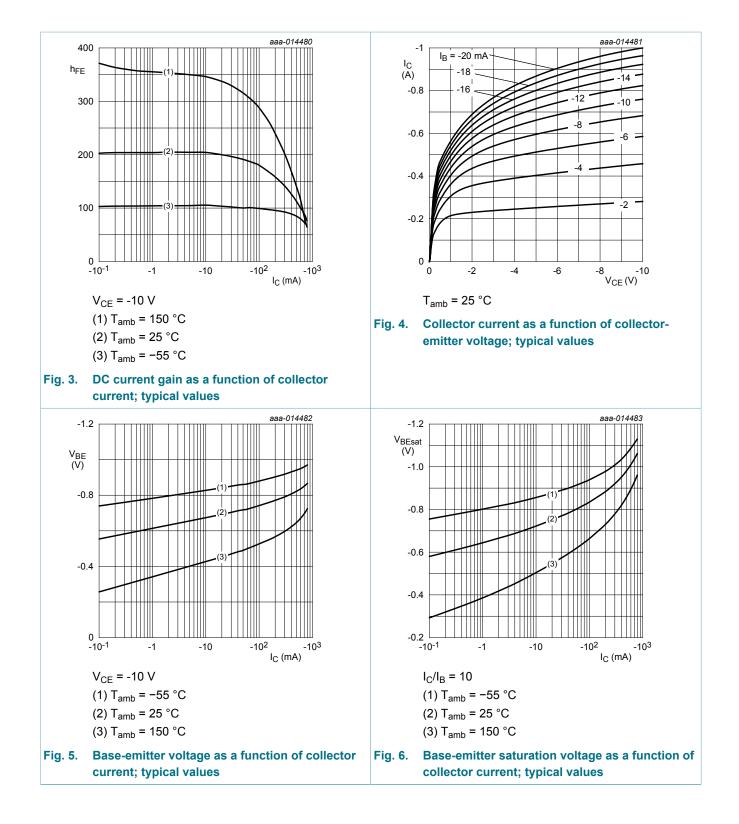
10. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|--------------------------------------|--|-----|-----|------|------|
| I _{CBO} | collector-base cut-off | V_{CB} = -50 V; I _E = 0 A; T _{amb} = 25 °C | - | - | -20 | nA |
| | current | V_{CB} = -50 V; I _E = 0 A; T _j = 125 °C | - | - | -20 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = -5 V; I _C = 0 A; T _{amb} = 25 °C | - | - | -50 | nA |
| h _{FE} | DC current gain | V_{CE} = -10 V; I _C = -0.1 mA; T _{amb} = 25 °C | 35 | - | - | |
| | | V_{CE} = -10 V; I _C = -1 mA; T _{amb} = 25 °C | 50 | - | - | |
| | | V_{CE} = -10 V; I _C = -10 mA; T _{amb} = 25 °C | 75 | - | - | |
| | | V_{CE} = -10 V; I _C = -150 mA; T _{amb} = 25 °C | 100 | - | 300 | |
| | | V _{CE} = -10 V; I _C = -500 mA; T _{amb} = 25 °C | 30 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | I_{C} = -150 mA; I_{B} = -15 mA; T_{amb} = 25 °C | - | - | -400 | mV |
| | | $I_{\rm C}$ = -500 mA; $I_{\rm B}$ = -50 mA; $T_{\rm amb}$ = 25 °C | - | - | -1.6 | V |
| V _{BEsat} | base-emitter saturation voltage | I_{C} = -150 mA; I_{B} = -15 mA; T_{amb} = 25 °C | - | - | -1.3 | V |
| | | I _C = -500 mA; I _B = -50 mA; T _{amb} = 25 °C | - | - | -2.6 | V |
| t _d | delay time | I _C = -150 mA; I _{Bon} = -15 mA; | - | - | 12 | ns |
| t _r | rise time | I _{Boff} = 15 mA; T _{amb} = 25 °C | - | - | 30 | ns |
| t _{on} | turn-on time | | - | - | 40 | ns |
| t _s | storage time | | - | - | 300 | ns |
| t _f | fall time | | - | - | 65 | ns |
| t _{off} | turn-off time | | - | - | 365 | ns |
| C _C | collector capacitance | V_{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C | - | - | 8 | pF |
| C _E | emitter capacitance | V_{EB} = -2 V; I _C = 0 A; i _c = 0 A; f = 1 MHz; T _{amb} = 25 °C | - | - | 30 | pF |
| f _T | transition frequency | V_{CE} = -20 V; I _C = -50 mA; f = 100 MHz; T _{amb} = 25 °C | 200 | - | - | MHz |

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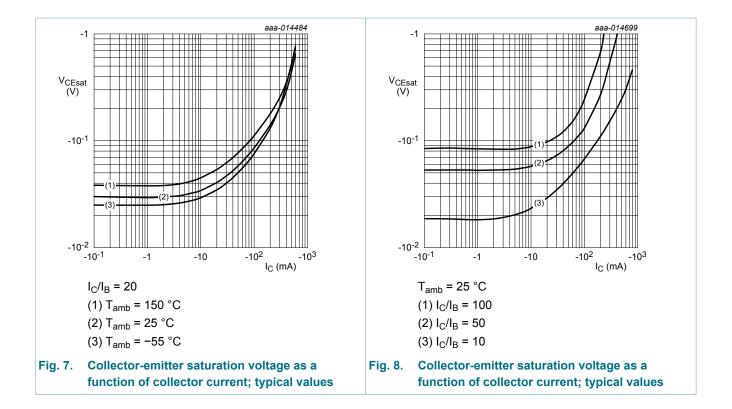
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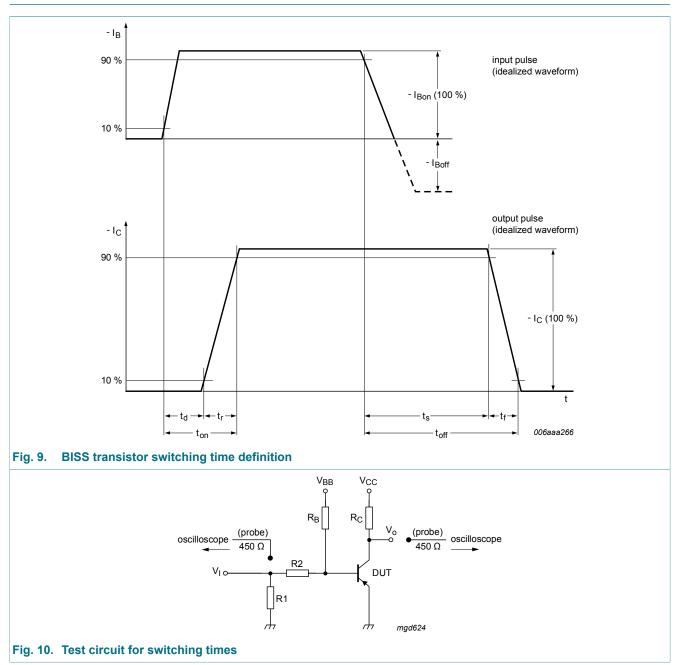
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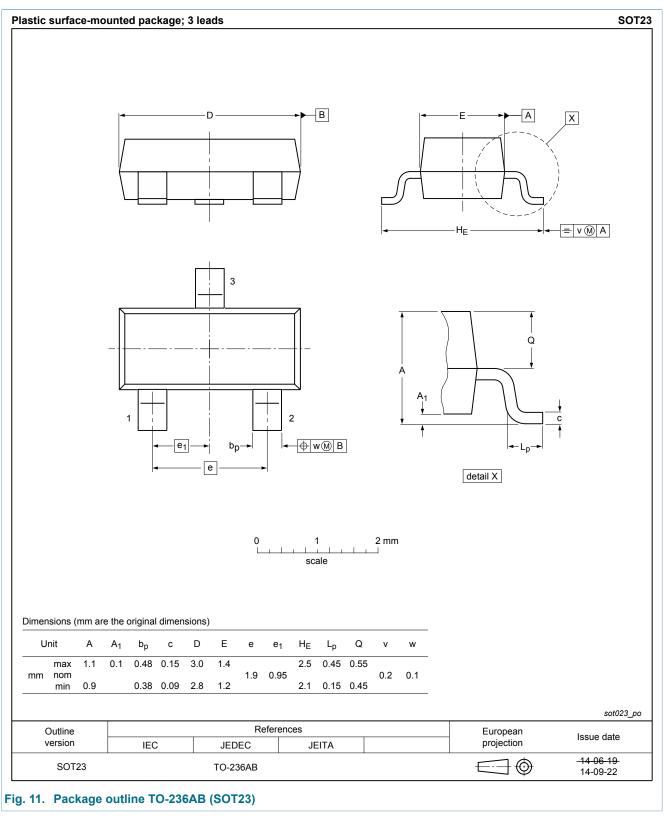
11. Test information

11.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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12. Package outline



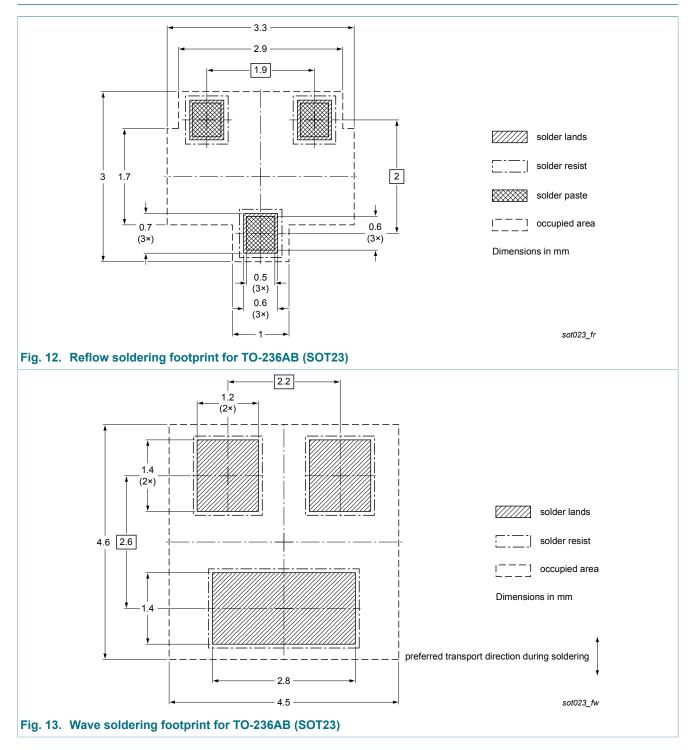
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13. Soldering



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14. Revision history

| Table 8. Revision | history | | | |
|----------------------------|--|---|-----------------------|----------------------------|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
| PMBT2907 v.5 | 20150306 | Product data sheet | - | PMBT2907_ PMBT2907A v.4 |
| Modifications: | of NXP Semicondu • Legal texts have b | data sheet has been redea uctors een adapted to the new co 29007_PMBT2907A split i | ompany name where app | propriate |
| PMBT2907_ PMBT2907A v.4 | 20040116 | Product data sheet | - | PMBT2907_ PMBT2907A v.3 |
| PMBT2907_ PMBT2907A v.3 | 19990427 | Product specification | - | PMBT2907_ PMBT2907A v.2 |
| PMBT2907_ PMBT2907A v.2 | 19970904 | Product specification | - | PMBT2907_ PMBT2907A v.1 |
| PMBT2907_ PMBT2907A v.1 | 19970507 | Product specification | - | - |

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15. Legal information

15.1 Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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